

Fig. 1

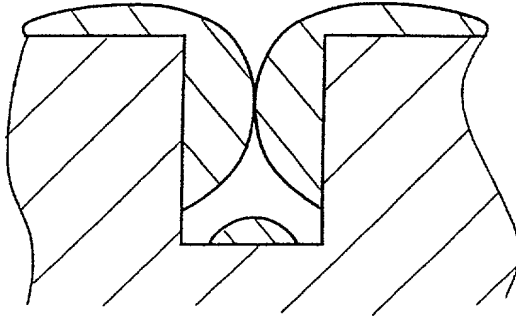


Fig. 2A

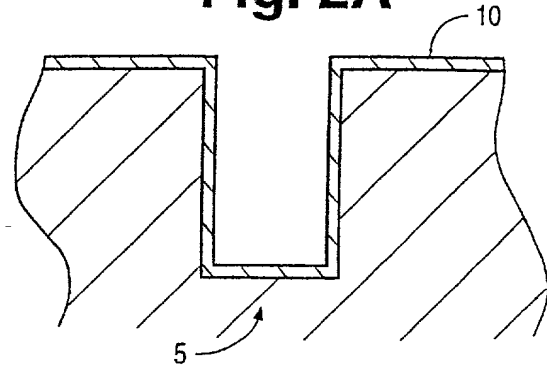


Fig. 2B

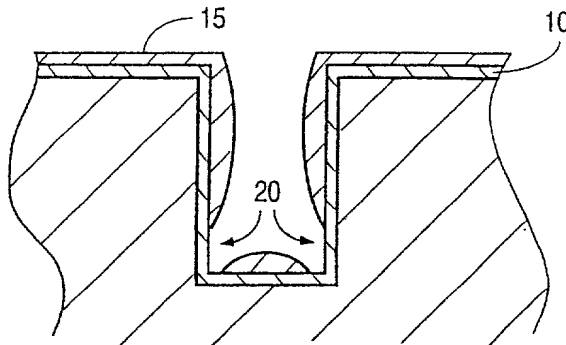


Fig. 2C

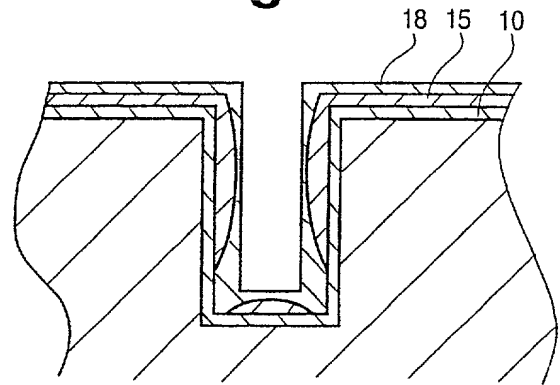


Fig. 2D

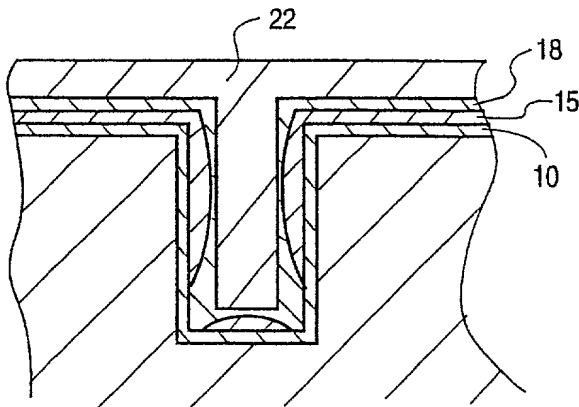
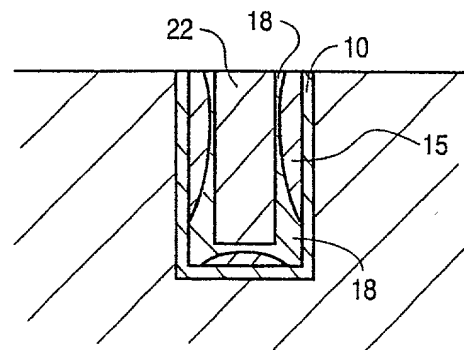
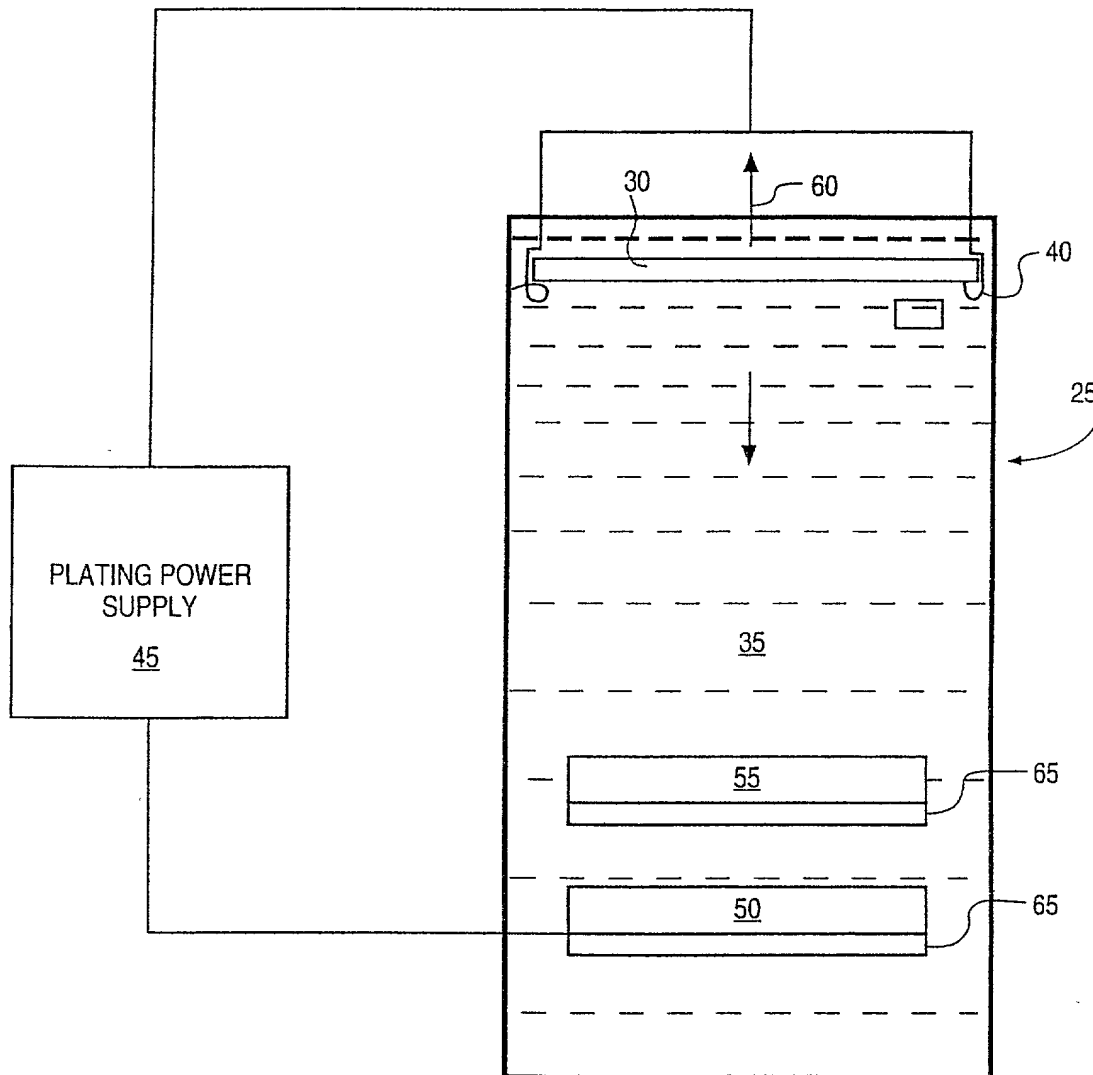


Fig. 2E

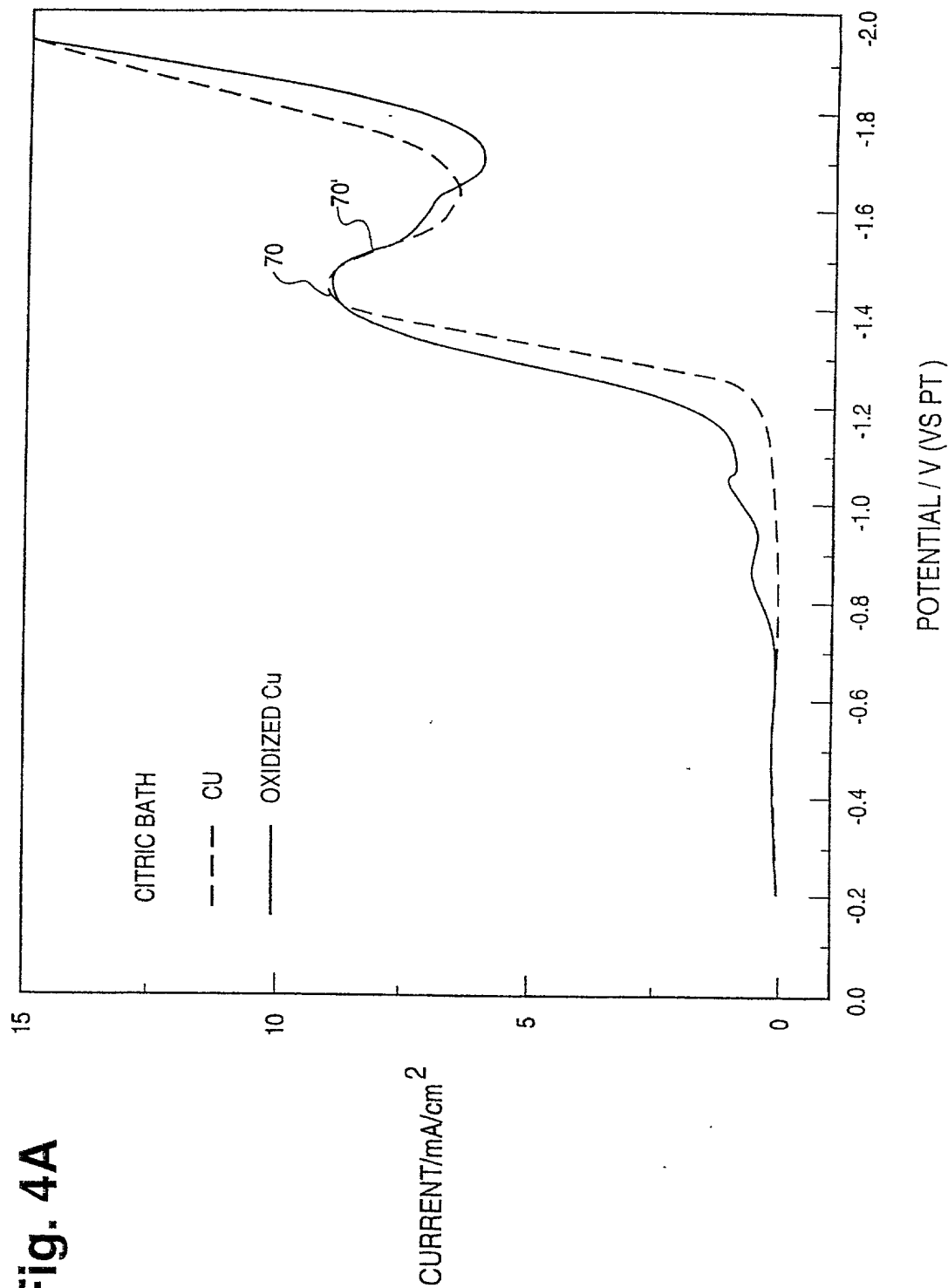


2/10

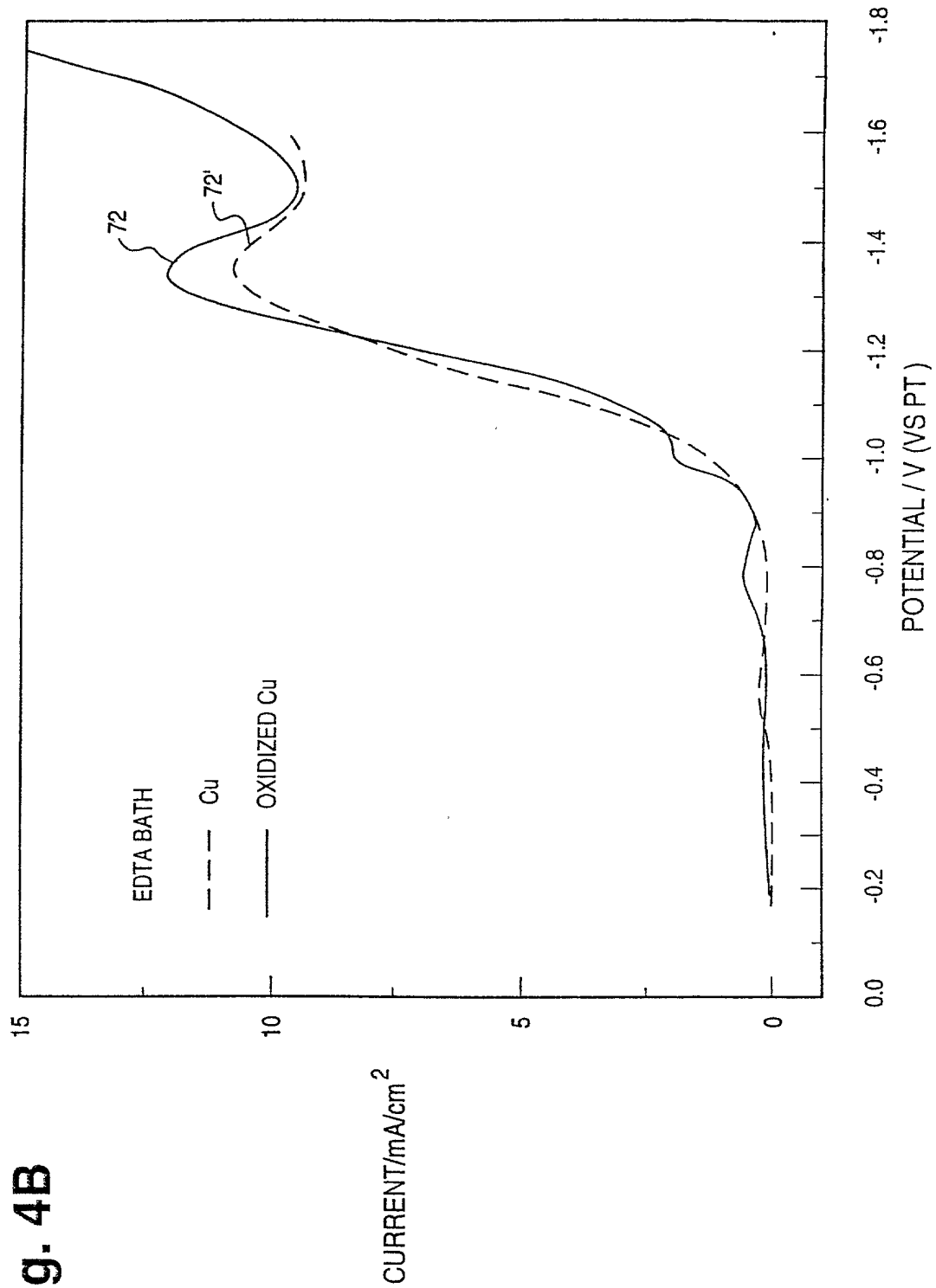
Fig. 3

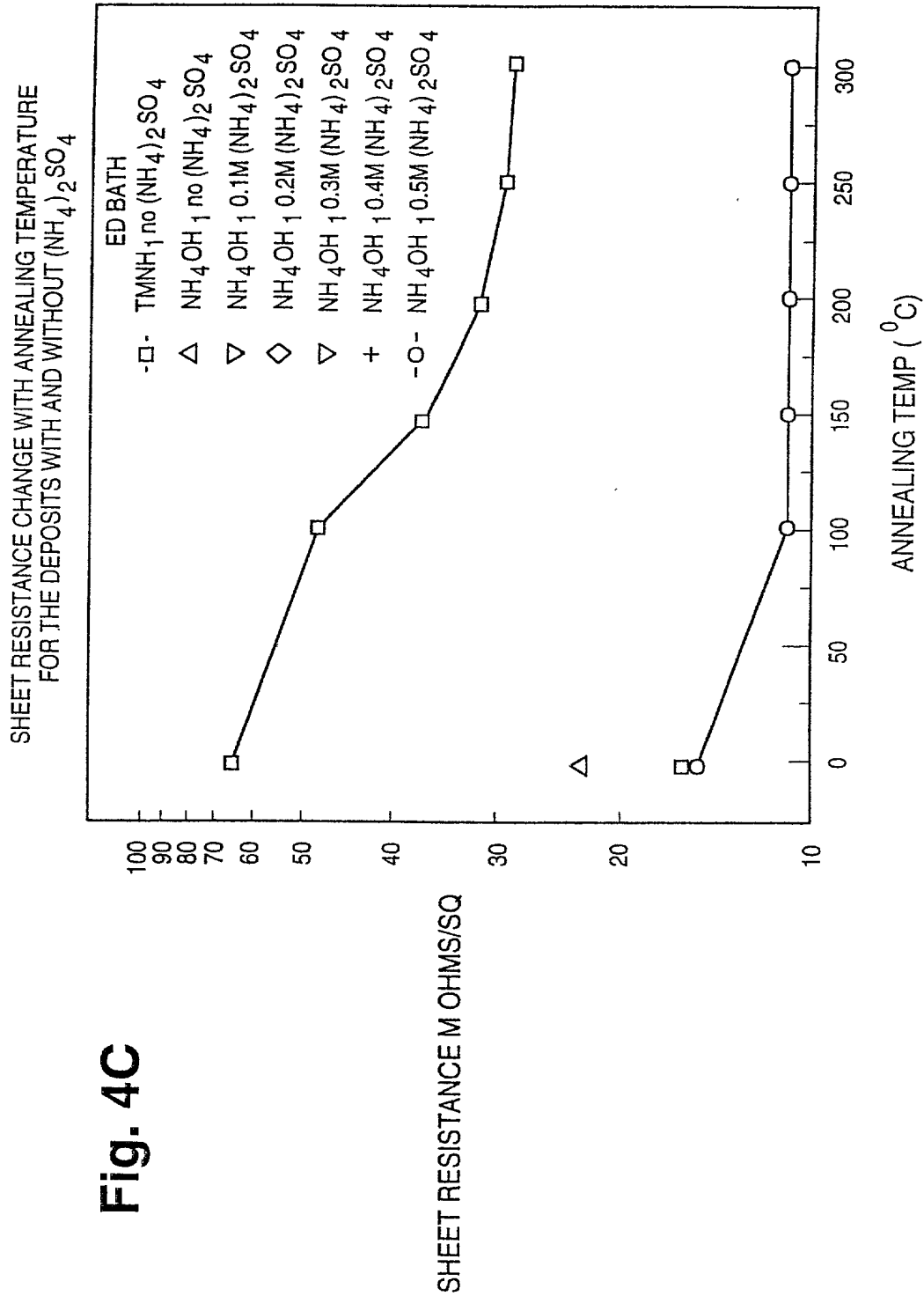


3/10

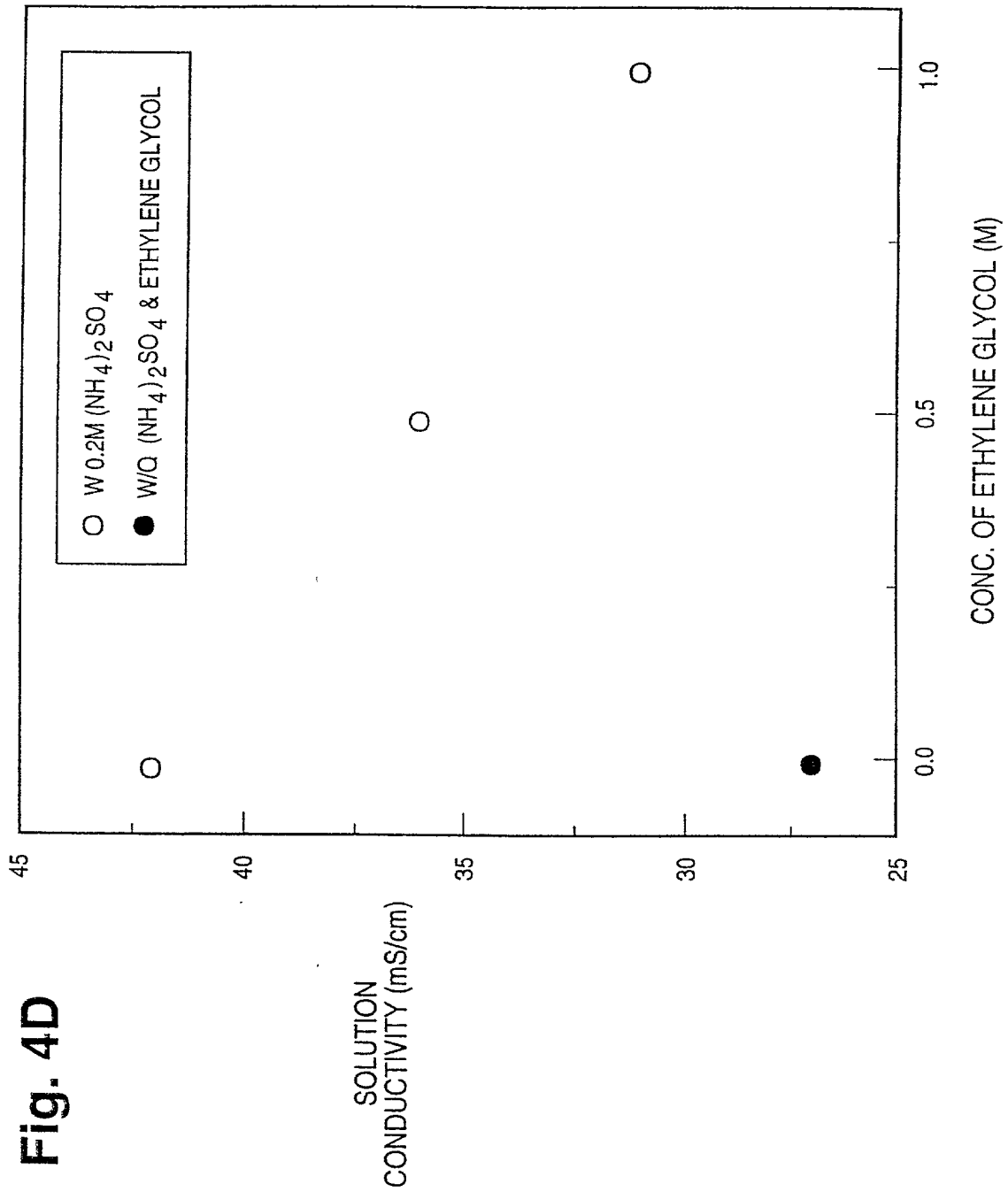


4/10





6/10



Title: APPARATUS AND METHOD FOR
ELECTROLYTICALLY DEPOSITING COPPER ON A
SEMICONDUCTOR WORKPIECE

Inventor: L. Chen
Docket No.: SEMT117581

7/10

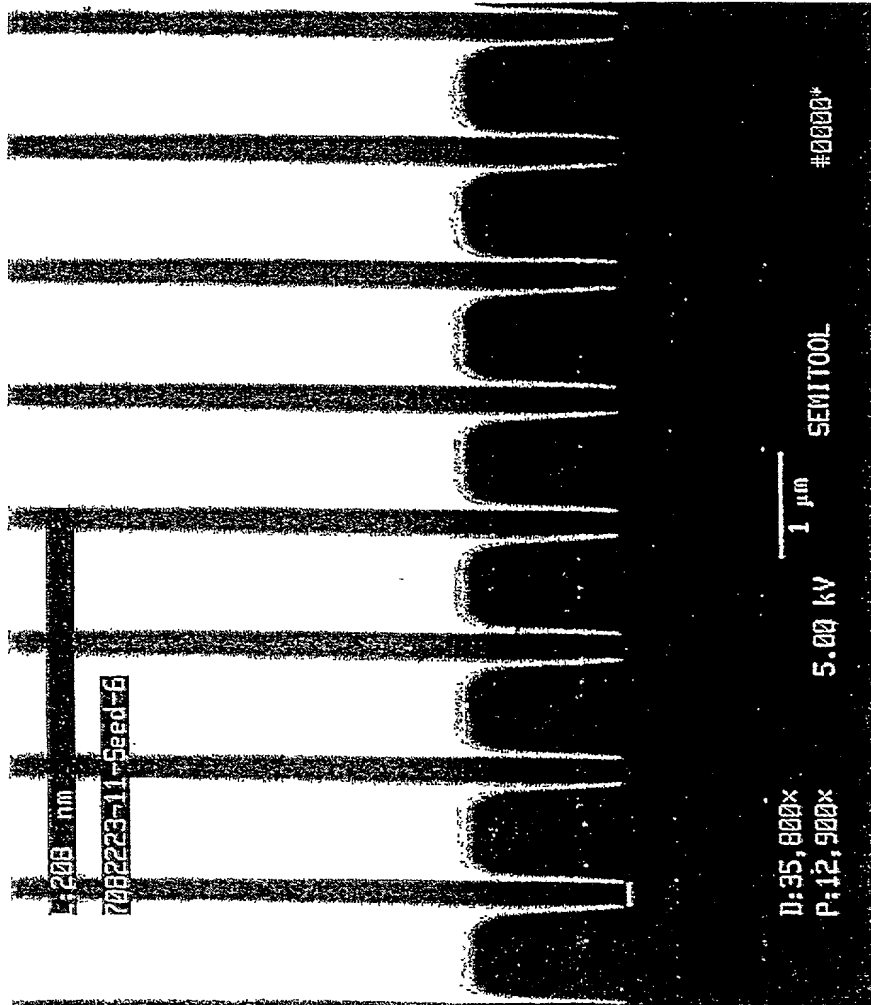


Fig. 5

Title: APPARATUS AND METHOD FOR
ELECTROLYTICALLY DEPOSITING COPPER ON A
SEMICONDUCTOR WORKPIECE

Inventor: L. Chen
Docket No.: SEMT117581

8/10

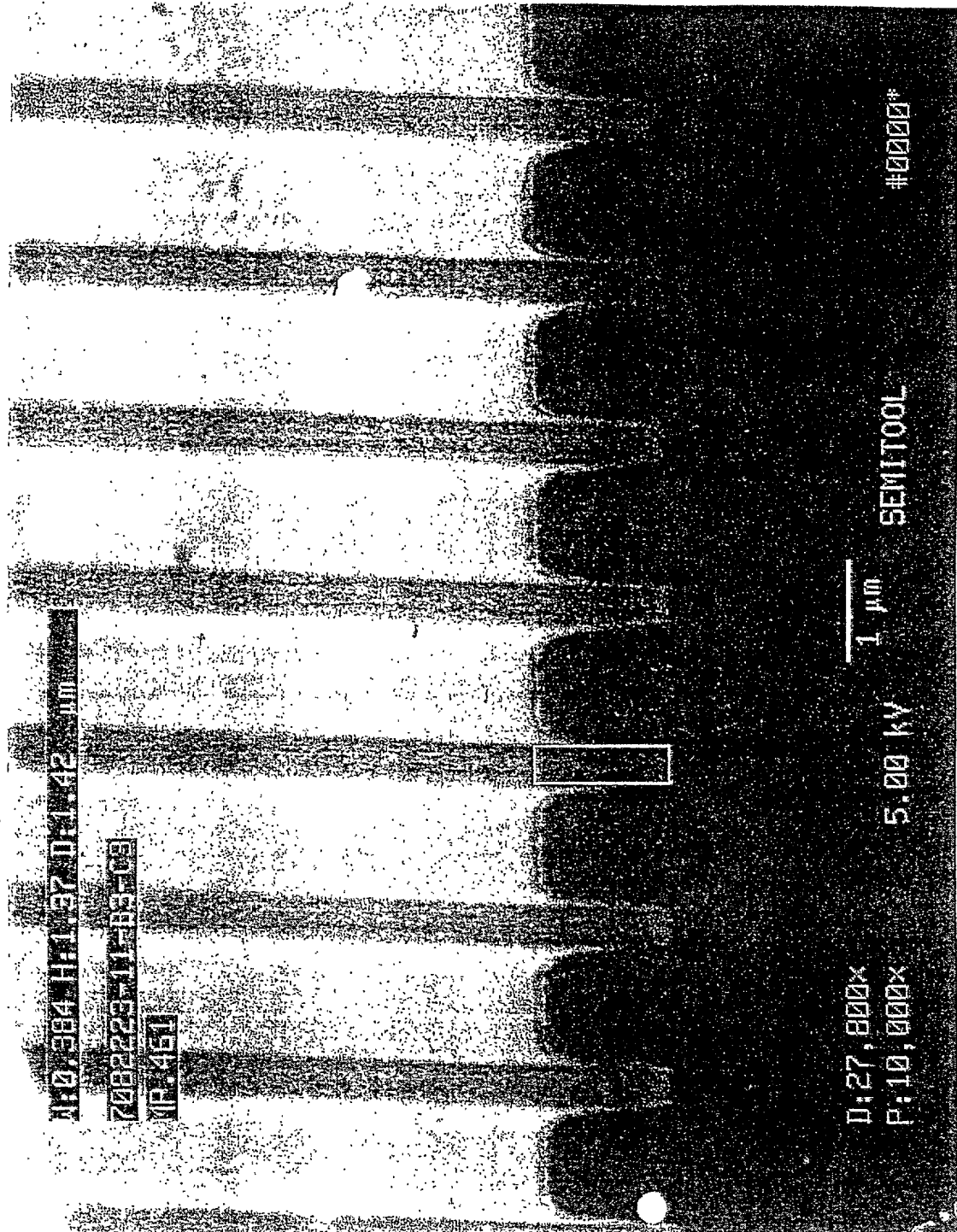


Fig. 6A

Title: APPARATUS AND METHOD FOR
ELECTROLYTICALLY DEPOSITING COPPER ON A
SEMICONDUCTOR WORKPIECE

Inventor: L. Chen
Docket No.: SEMT117581

9/10

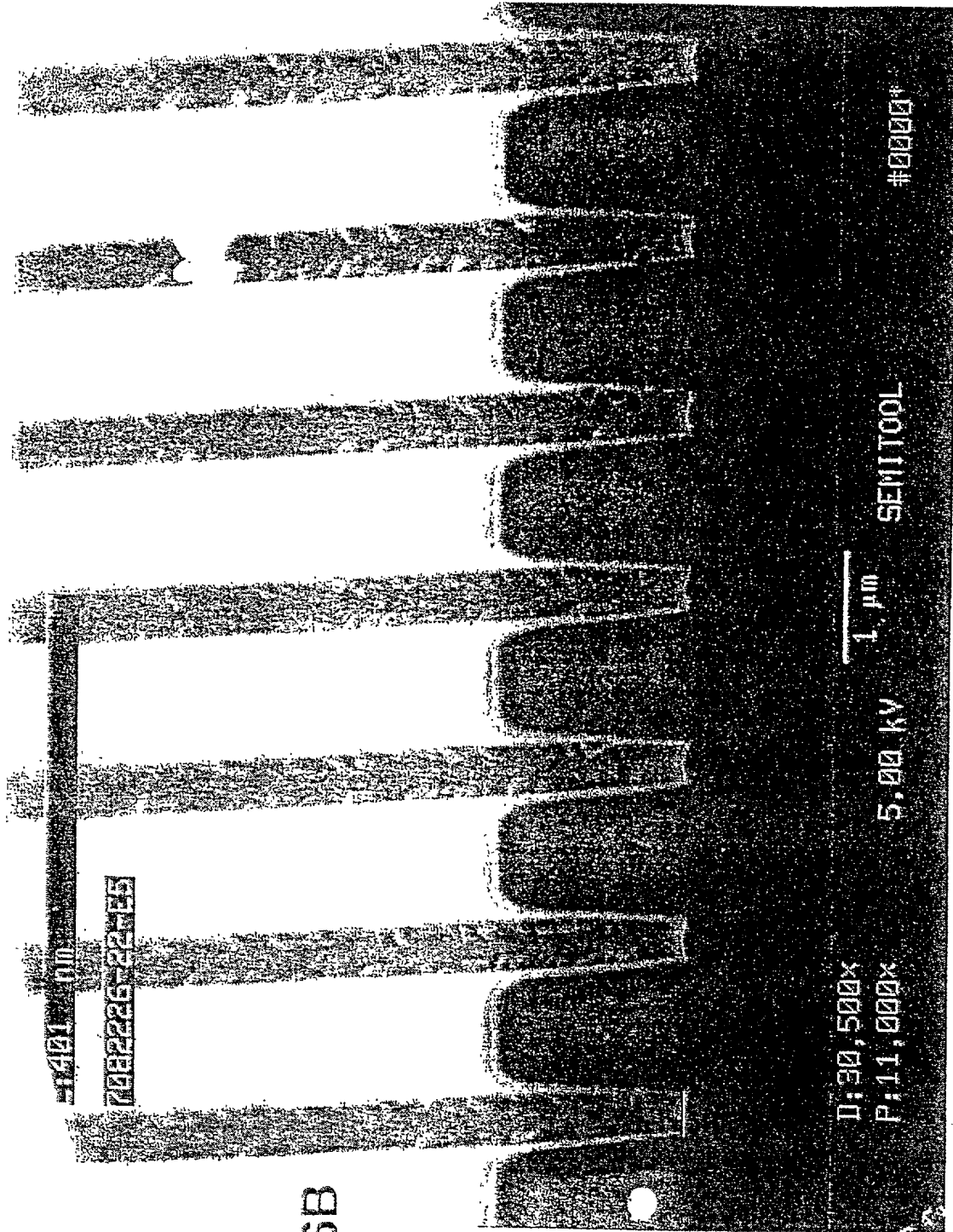


Fig. 6B

Fig. 7

